



Sample &

🖥 Buy





RI-I11-114A-S1 RI-I11-114B-S1

SCBS822C - NOVEMBER 2006 - REVISED JUNE 2014

RI-I11-114x-S1 Tag-it[™] HF-I Pro Transponder Inlays Square Not Recommended for New Designs

Features 1

Texas

Instruments

- ISO/IEC 15693-2, -3; ISO/IEC 18000-3 Compliant
- 13.56-MHz Operating Frequency
- 256-Bit User Memory in 8 blocks × 32-Bit
- User and Factory Lock Per Block
- Application Family Identifier (AFI)
- Fast Simultaneous Identification (Anti-Collision)
- Password Protected Write Command
- Command to Disable IC Functionality

2 Applications

- **Product Authentication**
- Ticketing
- Stored Value

3 Description

Texas Instruments Tag-it[™] HF-I pro transponder inlays consist of 13.56-MHz high-frequency (HF) transponders that are compliant with the ISO/IEC 15693 and ISO/IEC 18000-3 global open standards. These products offer a user-accessible memory of 256 bits, organized in eight blocks, and an extended command set including password protect write available in five different antenna shapes, with frequency offset for integration into paper, PVC, or other substrates.

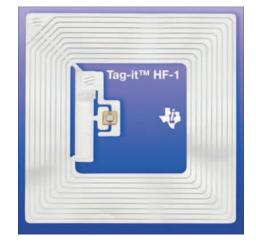
The Tag-it HF-I pro transponder inlays are manufactured with TI's patented laser tuning process to provide consistent read performance. Prior to delivery, the transponders undergo complete functional and parametric testing, in order to provide the high quality that customers have come to expect from TI.

The Tag-it HF-I pro transponder inlays are well suited for a variety of applications including, but not limited to, product authentication, library, supply-chain management, management, asset and ticketing/stored value applications.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)
RI-I11-114A-S1	TFB	45.00 mm x 45.00 mm
RI-I11-114B-S1	TFB	45.00 mm x 45.00 mm

(1)For all available packages, see the orderable addendum at the end of the datasheet.





INSTRUMENTS

Texas

www.ti.com

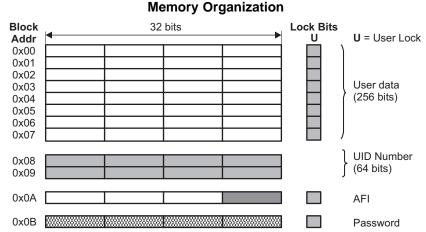
4 Revision History

Cł	Changes from Revision B (Sept 2011) to Revision C Page									
•	Changed feature from 8 bits x 32-bit blocks to 8 blocks x 32-Bit	1								
•	Changed spec from 8 bits x 32-bit blocks to 8 blocks x 32-Bit	3	6							

TEXAS INSTRUMENTS

www.ti.com

5 Pin Configuration and Functions



6 Specifications

Table 1. Specifications⁽¹⁾

	PART NUMB	ER				
	RI-I11-114A-S1	RI-I11-114B-S1				
Supported standard	ISO/IEC 15693-2, -3; ISO	D/IEC 18000-3				
Recommended operating frequency	13.56 MHz					
Passive resonance frequency (at 25°C)	13.86 MHz ±200 kHz (includes frequency offset to compensate further integration into paper)	14.4 MHz ±200 kHz (includes frequency offset to compensate PVC lamination)				
Typical required activation field strength to read (at 25°C)	98 dBµA/m ⁽²⁾	98 dBµA/m ⁽³⁾				
Typical required activation field strength to write (at 25°C)	101 dBµA/m ⁽²⁾	101 dBµA/m ⁽³⁾				
Factory-programmed read-only number	64 bits					
Memory (user programmable)	256 bits organized in 8 b	olocks × 32-Bit				
Typical programming cycles (at 25°C)	100,000					
Data retention time (at 55°C)	>10 years					
Simultaneous identification of tags	Up to 50 tags per second (reader/antenna dependent)					
Antenna size	45 mm × 45 mm (~1.77	in × ~1.77 in)				
Foil width	48 mm ± 0.5 mm (1.89	in ± 0.02 in)				
Foil pitch	50.8 mm +0.1 mm/–0	.4 mm (2 in)				
Base material	Substrate: PET (polyethylenethereph	talate); Antenna: aluminum				
Thickness	Chip area: 0.34 m Antenna area (Al both sides Antenna area (Al one side):): 0.085 mm ±0.01				
Operating temperature	–25°C to 70	C				
Storage temperature (single inlay)	-40°C to 85°C (warpage may occur a	t upper temperature range)				
Storage temperature (on reel)	-40°C to 40°C					
Delivery	Single-row tape wound on cardboard reel with 500-mm diameter Reel outer width: approximately 60 mm (about 2.36 inches) Reel inner width: approximately 50 mm (about 1.97 inches) Hub diameter: 76.2 mm (3 in)					
Typical quantity of good units per reel	5000					

(1) For highest possible read-out coverage, operate readers at a modulation depth of 20% or higher.

(2) After integration into paper

(3) After PVC lamination

RI-I11-114A-S1 RI-I11-114B-S1

SCBS822C-NOVEMBER 2006-REVISED JUNE 2014

TEXAS INSTRUMENTS

www.ti.com

Table 2. Supported Command Set

DEOLICET	REQUEST MODE ⁽¹⁾								
REQUEST	REQUEST CODE	INVENTORY	ADDRESSED	NON-ADDRESSED	AFI	OPT. FLAG			
ISO 15693 Mandatory and Optional Commands									
Inventory	0x01	1	-	-	1	0			
Stay Quiet	0x02	-	\checkmark	-	_	0			
Read_Single_Block	0x20	-	\checkmark	1	_	1			
Write_Single_Block	0x21	-	\checkmark	1	-	1			
Lock_Block	0x22	-	\checkmark	1	_	1			
TI Custom Commands									
Kill	0xA4	-	\checkmark	-	-	1			
WriteSingleBlockPwd	0xA5	-	\checkmark	-	-	1			

(1) \checkmark = Implemented, - = Not applicable

Copyright © 2006–2014, Texas Instruments Incorporated



www.ti.com

7 Device and Documentation Support

7.1 Documentation Support

7.1.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

PARTS	PRODUCT FOLDER	SAMPLE & BUY	TECHNICAL DOCUMENTS	TOOLS & SOFTWARE	SUPPORT & COMMUNITY	
RI-I11-114A-S1	Click here	Click here	Click here	Click here	Click here	
RI-I11-114B-S1	Click here	Click here	Click here	Click here	Click here	

Table 3. Related Links

7.2 Trademarks

Tag-it is a trademark of Texas Instruments.

7.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

7.4 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

8 Mechanical, Packaging, and Orderable Information

The following pages include mechanical packaging and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



1-Jun-2017

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
RI-I11-114B-S1	NRND	RFIDN	TFB	0		TBD	Call TI	Call TI	-25 to 70		

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

IMPORTANT NOTICE

Texas Instruments Incorporated (TI) reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete.

TI's published terms of sale for semiconductor products (http://www.ti.com/sc/docs/stdterms.htm) apply to the sale of packaged integrated circuit products that TI has qualified and released to market. Additional terms may apply to the use or sale of other types of TI products and services.

Reproduction of significant portions of TI information in TI data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such reproduced documentation. Information of third parties may be subject to additional restrictions. Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyers and others who are developing systems that incorporate TI products (collectively, "Designers") understand and agree that Designers remain responsible for using their independent analysis, evaluation and judgment in designing their applications and that Designers have full and exclusive responsibility to assure the safety of Designers' applications and compliance of their applications (and of all TI products used in or for Designers' applications) with all applicable regulations, laws and other applicable requirements. Designer represents that, with respect to their applications, Designer has all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. Designer agrees that prior to using or distributing any applications that include TI products, Designer will thoroughly test such applications and the functionality of such TI products as used in such applications.

TI's provision of technical, application or other design advice, quality characterization, reliability data or other services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using TI Resources in any way, Designer (individually or, if Designer is acting on behalf of a company, Designer's company) agrees to use any particular TI Resource solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

Designer is authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY DESIGNER AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

Unless TI has explicitly designated an individual product as meeting the requirements of a particular industry standard (e.g., ISO/TS 16949 and ISO 26262), TI is not responsible for any failure to meet such industry standard requirements.

Where TI specifically promotes products as facilitating functional safety or as compliant with industry functional safety standards, such products are intended to help enable customers to design and create their own applications that meet applicable functional safety standards and requirements. Using products in an application does not by itself establish any safety features in the application. Designers must ensure compliance with safety-related requirements and standards applicable to their applications. Designer may not use any TI products in life-critical medical equipment unless authorized officers of the parties have executed a special contract specifically governing such use. Life-critical medical equipment is medical equipment where failure of such equipment would cause serious bodily injury or death (e.g., life support, pacemakers, defibrillators, heart pumps, neurostimulators, and implantables). Such equipment includes, without limitation, all medical devices identified by the U.S. Food and Drug Administration as Class III devices and equivalent classifications outside the U.S.

TI may expressly designate certain products as completing a particular qualification (e.g., Q100, Military Grade, or Enhanced Product). Designers agree that it has the necessary expertise to select the product with the appropriate qualification designation for their applications and that proper product selection is at Designers' own risk. Designers are solely responsible for compliance with all legal and regulatory requirements in connection with such selection.

Designer will fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of Designer's noncompliance with the terms and provisions of this Notice.

> Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2017, Texas Instruments Incorporated